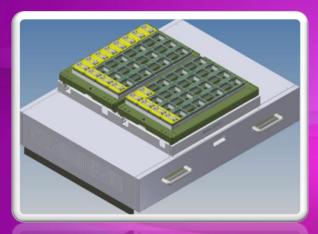
HIFIX Board

This HIFIX is for requirements including precision docking and high reliability. HIFIX product lineup offers support for requirements including memory, wafer, and manual test. This variety allows us to provide solutions optimized to specific test frequencies and device packages. To ensure maximum quality of performance, all functions of the HIFIX, including continuity and AC/DC checks, are performed throughout the manufacturing process.



HIFIX Board	Layer	Density (ea)	Socket Insert Type	Board Size (mm)
Engineer board (DDR3, DDR2, SRAM, Flash, Etc.)	6~18	64 or 128	DUT board	870 x 655 1094 x 655

^{*} Depending on a customer's request, density would be changed.

DI Corporation ***

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